LM195/LM395 Ultra Reliable Power Transistors

Check for Samples: LM195, LM395

FEATURES

- **Internal Thermal Limiting**
- **Greater than 1.0A Output Current**
- **3.0 µA Typical Base Current**
- **500 ns Switching Time**
- **2.0V Saturation**
- **Base Can be Driven up to 40V without Damage**
- **Directly Interfaces with CMOS or TTL**
- **100% Electrical Burn-in**

DESCRIPTION

The LM195/LM395 are fast, monolithic power integrated circuits with complete overload protection. These devices, which act as high gain power transistors, have included on the chip, current limiting, power limiting, and thermal overload protection making them virtually impossible to destroy from any type of overload. In the standard TO-3 transistor power package, the LM195 will deliver load currents in excess of 1.0A and can switch 40V in 500 ns.

The inclusion of thermal limiting, a feature not easily available in discrete designs, provides virtually absolute protection against overload. Excessive power dissipation or inadequate heat sinking causes the thermal limiting circuitry to turn off the device preventing excessive heating.

The LM195 offers a significant increase in reliability as well as simplifying power circuitry. In some applications, where protection is unusually difficult, such as switching regulators, lamp or solenoid drivers where normal power dissipation is low, the LM195 is especially advantageous.

The LM195 is easy to use and only a few precautions need be observed. Excessive collector to emitter voltage can destroy the LM195 as with any power transistor. When the device is used as an emitter follower with low source impedance, it is necessary to insert a 5.0k resistor in series with the base lead to prevent possible emitter follower oscillations. Although the device is usually stable as an emitter follower, the resistor eliminates the possibility of trouble without degrading performance. Finally, since it has good high frequency response, supply bypassing is recommended.

For low-power applications (under 100 mA), refer to the LP395 Ultra Reliable Power Transistor.

The LM195/LM395 are available in the standard TO-3, Kovar TO-5, and TO-220 packages. The LM195 is rated for operation from −55°C to +150°C and the LM395 from 0°C to +125°C.

Simplified Circuit

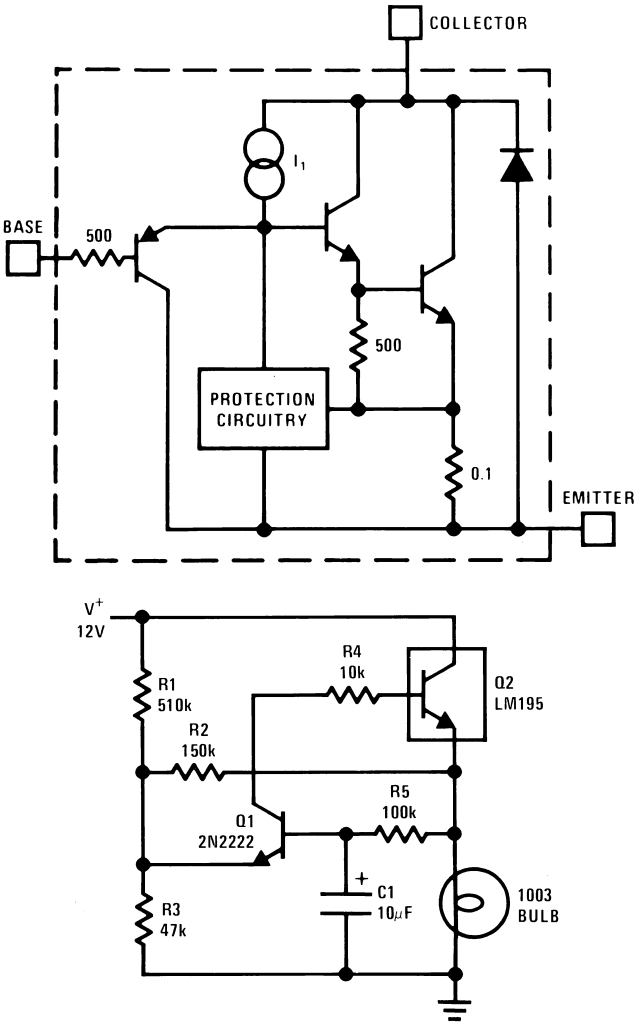
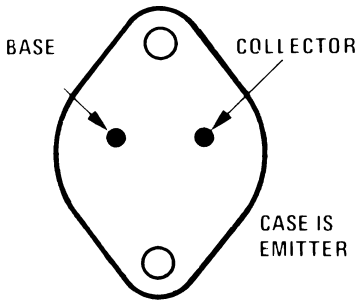


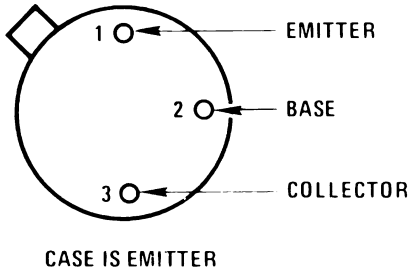
Figure 1. 1.0 Amp Lamp Flasher

Connection Diagram



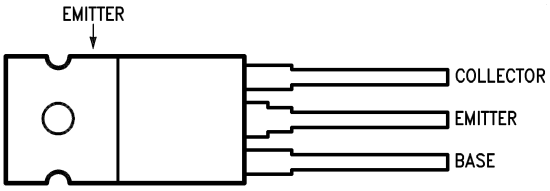
Refer to RETS195H and RETS195K drawings of military LM195H and LM195K versions for specifications.

Figure 2. TO-3 Metal Can Package
Bottom View
See Package Number NDS0002A



Refer to RETS195H and RETS195K drawings of military LM195H and LM195K versions for specifications.

Figure 3. TO-5 Metal Can Package
Bottom View



Case is Emitter

Figure 4. TO-220 Plastic Package
Top View
See Package Number NDE0003B

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ABSOLUTE MAXIMUM RATINGS(1)(2)

Collector to Emitter Voltage	
LM195	42V
LM395	36V
Collector to Base Voltage	
LM195	42V
LM395	36V
Base to Emitter Voltage (Forward) LM195 LM395	 42V 36V
Base to Emitter Voltage (Reverse)	20V
Collector Current	Internally Limited
Power Dissipation	Internally Limited
Operating Temperature Range	
LM195	−55°C to +150°C
LM395	0°C to +125°C
Storage Temperature Range	−65°C to +150°C
Lead Temperature	
(Soldering, 10 sec.)	260°C

(1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits.
(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

PRECONDITIONING

100% Burn-In In Thermal Limit

ELECTRICAL CHARACTERISTICS

Parameter	Conditions	LM195			LM395			Units
		Min	Typ	Max	Min	Typ	Max	
Collector-Emitter Operating Voltage (2)	$I_Q \le I_C \le I_{MAX}$			42			36	V
Base to Emitter Breakdown Voltage	$0 \le V_{CE} \le V_{CEMAX}$	42			36	60		V
Collector Current								
TO-3, TO-220	$V_{CE} \le 15V$	1.2	2.2		1.0	2.2		A
TO-5	$V_{CE} \le 7.0V$	1.2	1.8		1.0	1.8		A
Saturation Voltage	$I_C \le 1.0A$, $T_A = 25°C$		1.8	2.0		1.8	2.2	V
Base Current	$0 \le I_C \le I_{MAX}$ $0 \le V_{CE} \le V_{CEMAX}$		3.0	5.0		3.0	10	μA
Quiescent Current (I_Q)	$V_{be} = 0$ $0 \le V_{CE} \le V_{CEMAX}$		2.0	5.0		2.0	10	mA
Base to Emitter Voltage	$I_C = 1.0A$, $T_A = +25°C$		0.9			0.9		V
Switching Time	$V_{CE} = 36V$, $R_L = 36\Omega$, $T_A = 25°C$		500			500		ns

(1) Unless otherwise specified, these specifications apply for −55°C ≤ T_j ≤ +150°C for the LM195 and 0°C ≤ +125°C for the LM395.
(2) Selected devices with higher breakdown available.

ELECTRICAL CHARACTERISTICS (continued)

(1)

Parameter	Conditions	LM195			LM395			Units
		Min	Typ	Max	Min	Typ	Max	
Thermal Resistance Junction to Case (3)	TO-3 Package (NDS)		2.3	3.0		2.3	3.0	°C/W
	TO-5 Package		12	15		12	15	°C/W
	TO-220 Package (NDE)					4	6	°C/W

(3) Without a heat sink, the thermal resistance of the TO-5 package is about +150°C/W, while that of the TO-3 package is +35°C/W.

TYPICAL PERFORMANCE CHARACTERISTICS

(for NDS and NDE Packages)

Collector Characteristics

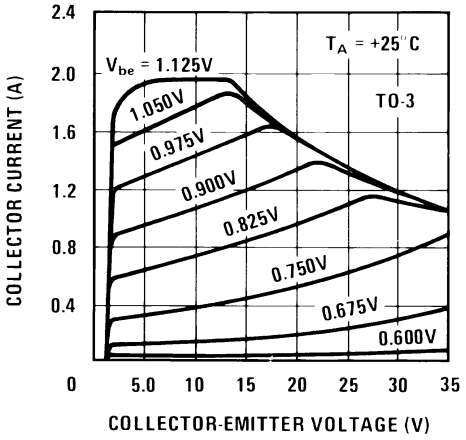


Figure 5.

Short Circuit Current

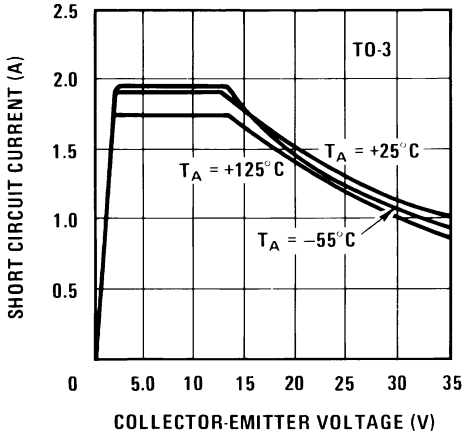


Figure 6.

Bias Current

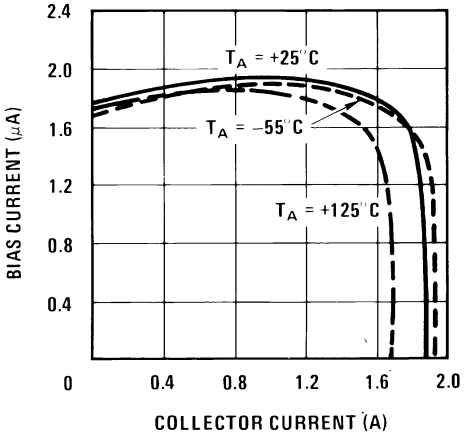


Figure 7.

Quiescent Current

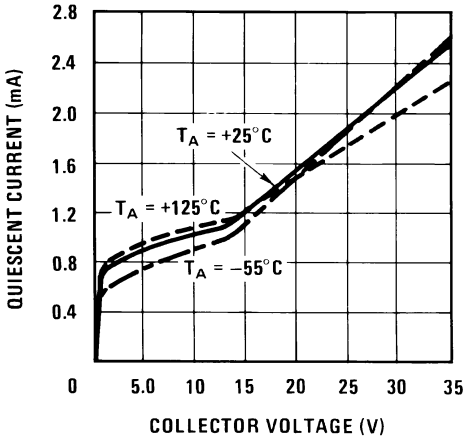


Figure 8.

Base Emitter Voltage

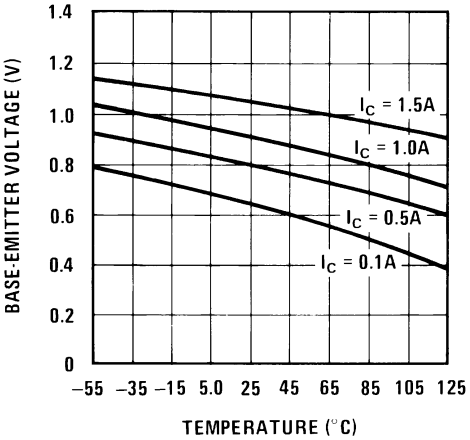


Figure 9.

Base Current

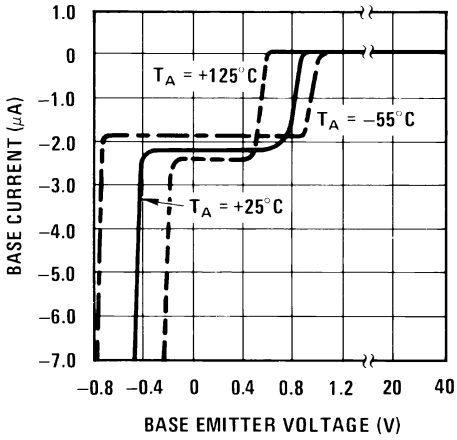


Figure 10.

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

(for NDS and NDE Packages)

Saturation Voltage

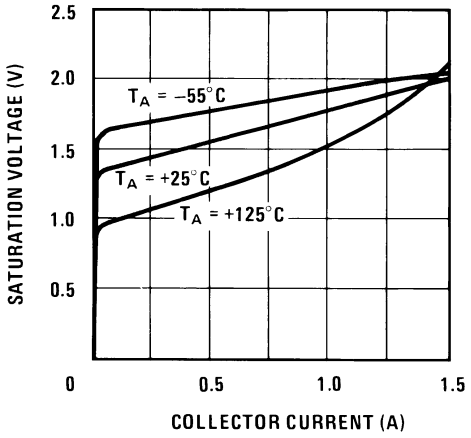


Figure 11.

Response Time

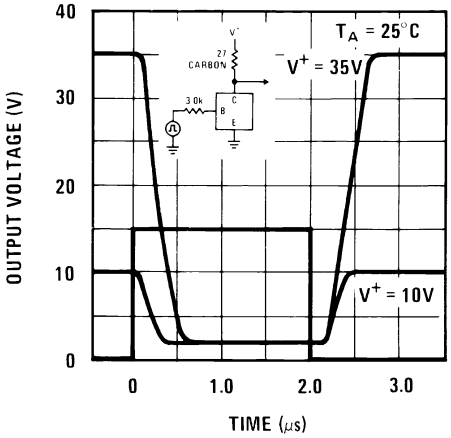


Figure 12.

Response Time

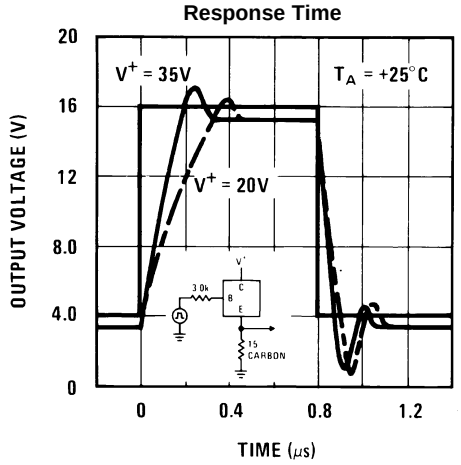


Figure 13.

10V Transfer Function

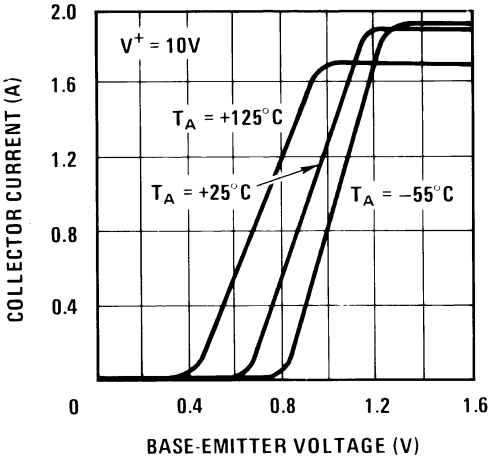


Figure 14.

36V Transfer Function

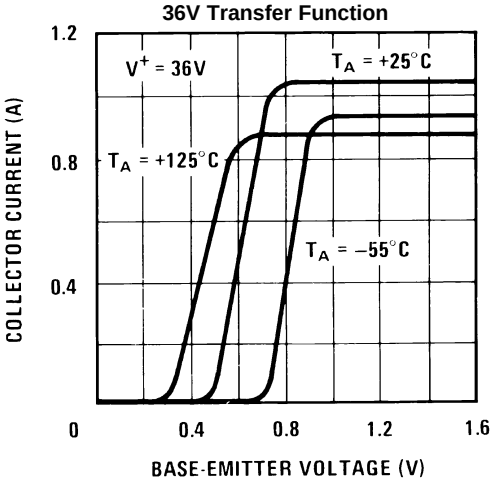


Figure 15.

Transconductance

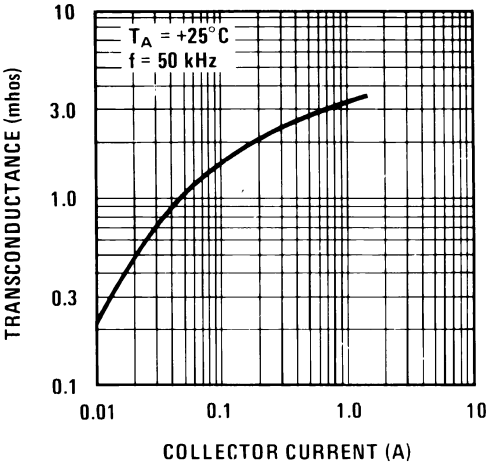


Figure 16.

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

(for NDS and NDE Packages)

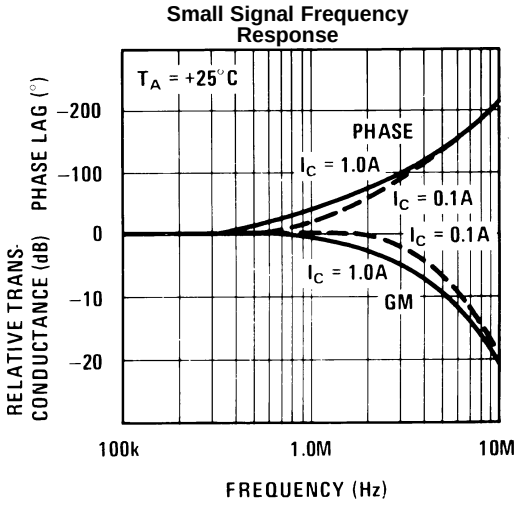
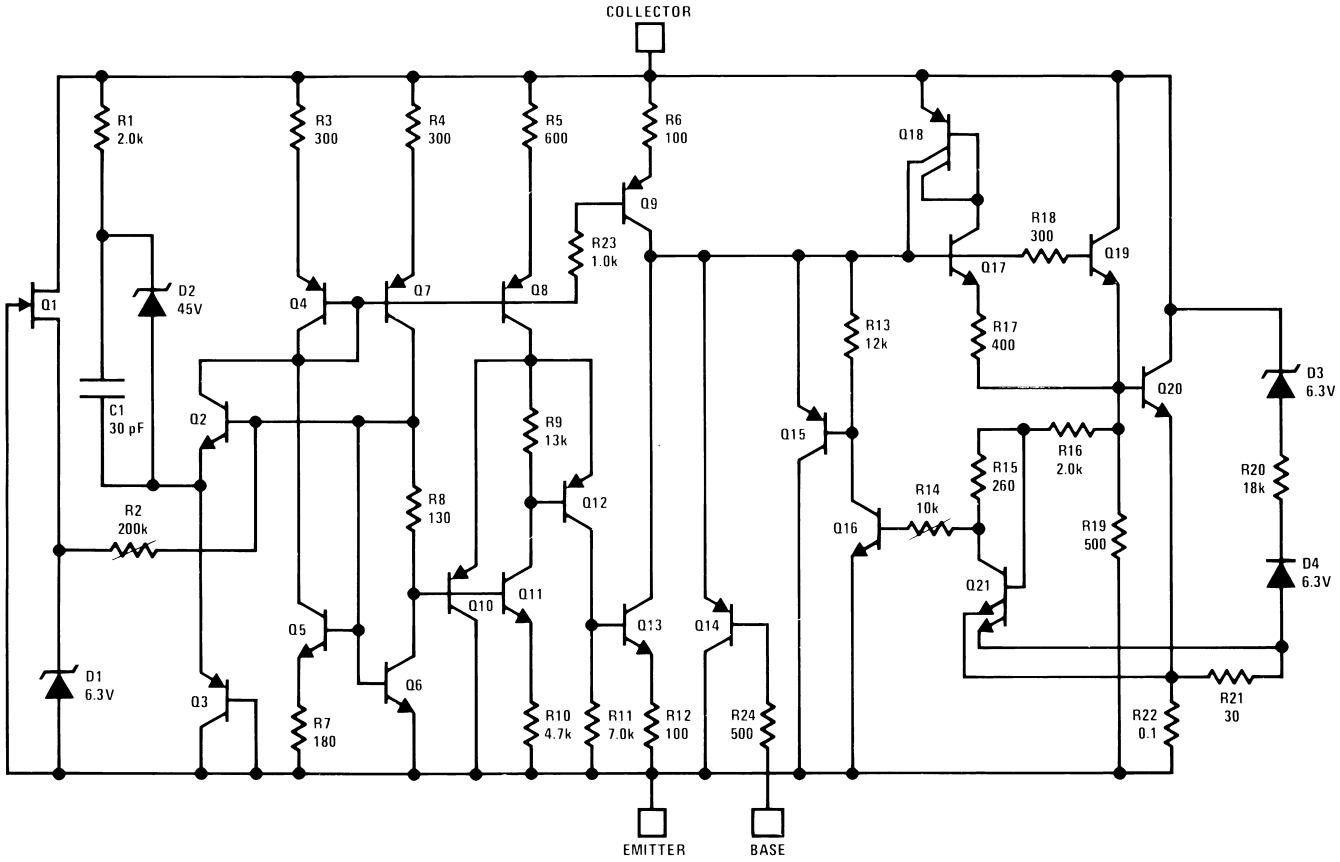
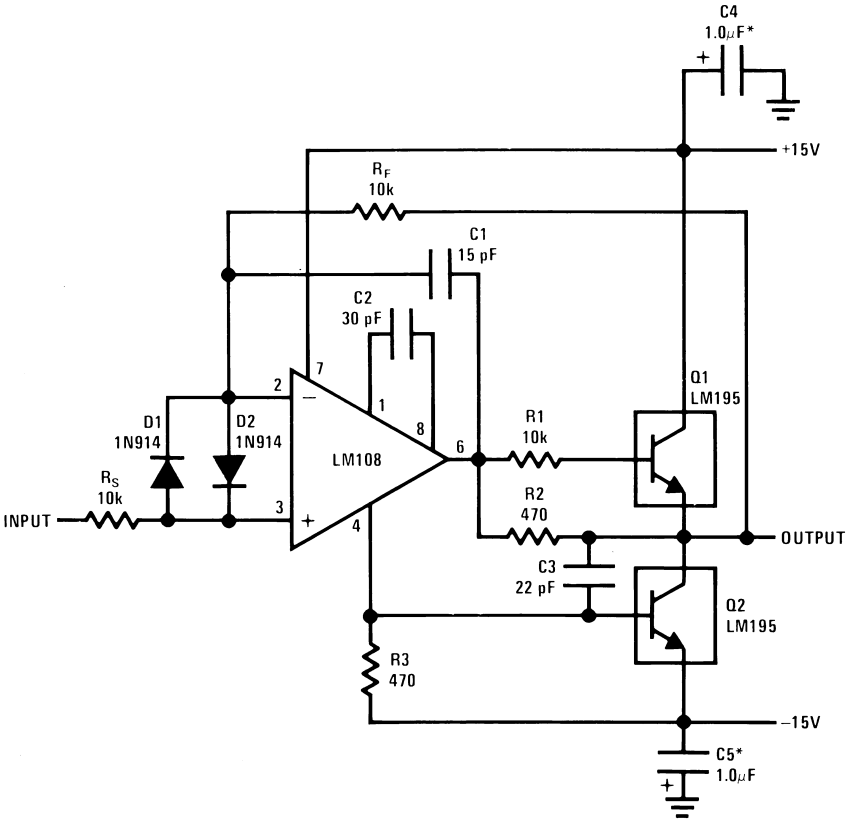


Figure 17.

SCHEMATIC DIAGRAM

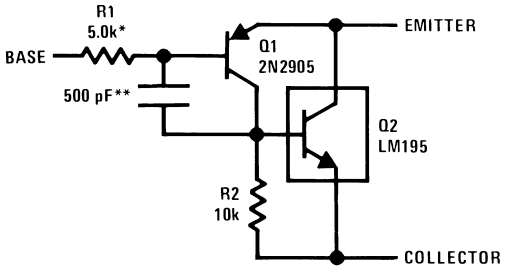


TYPICAL APPLICATIONS



*Solid Tantalum

Figure 18. 1.0 Amp Voltage Follower



*Protects against excessive base drive
**Needed for stability

Figure 19. Power PNP

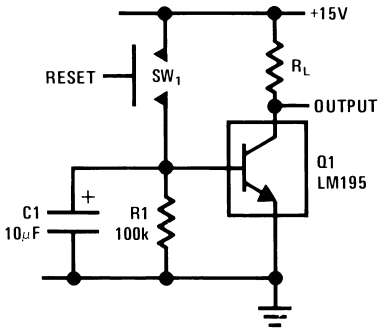


Figure 20. Time Delay

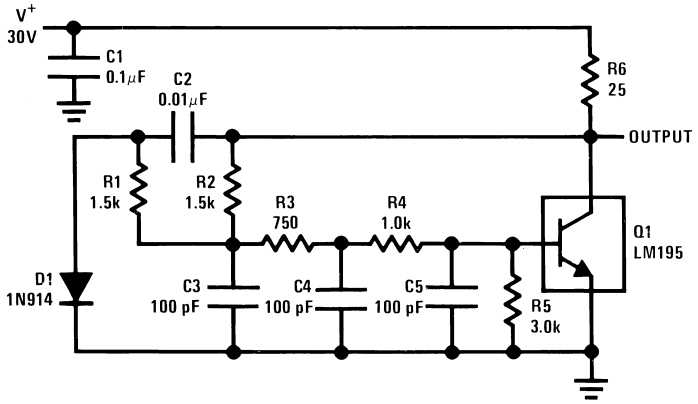
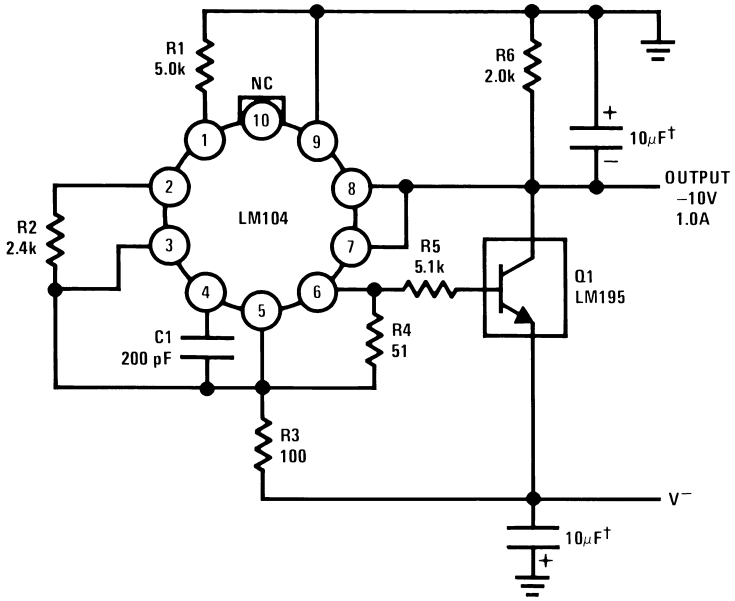
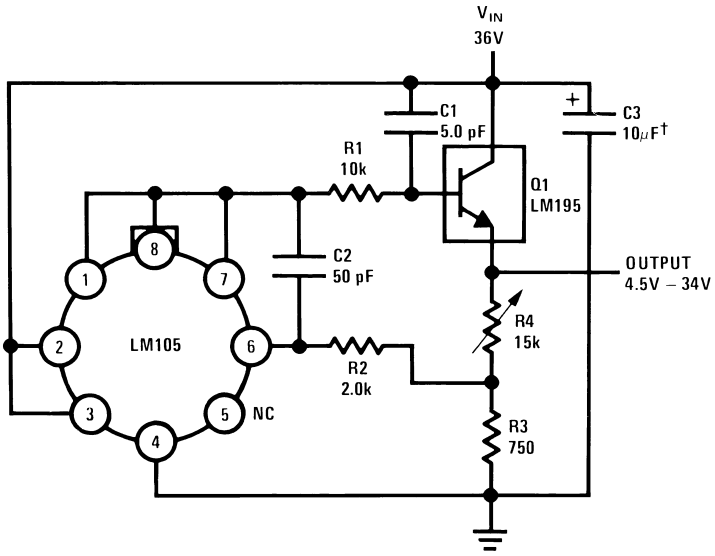


Figure 21. 1.0 MHz Oscillator



†Solid Tantalum

Figure 22. 1.0 Amp Negative Regulator



†Solid Tantalum

Figure 23. 1.0 Amp Positive Voltage Regulator

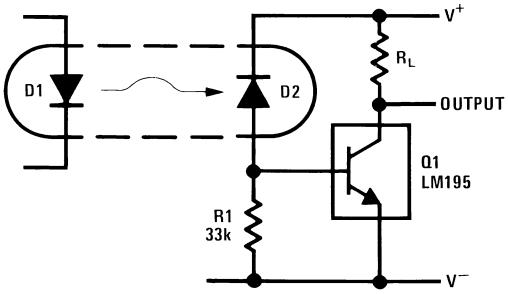


Figure 24. Fast Optically Isolated Switch

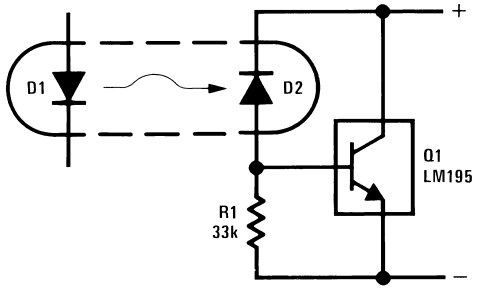


Figure 25. Optically Isolated Power Transistor

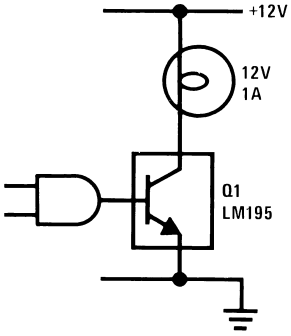


Figure 26. CMOS or TTL Lamp Interface

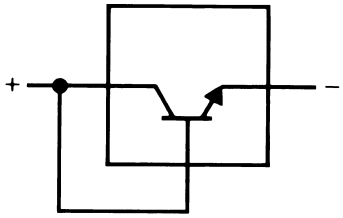
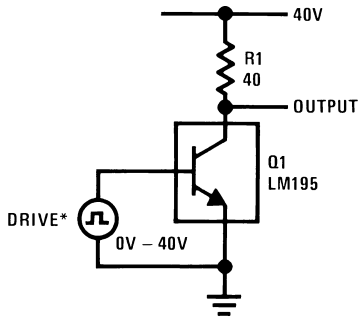


Figure 27. Two Terminal Current Limiter



*Drive Voltage 0V to ≥ 10V ≤ 42V

Figure 28. 40V Switch

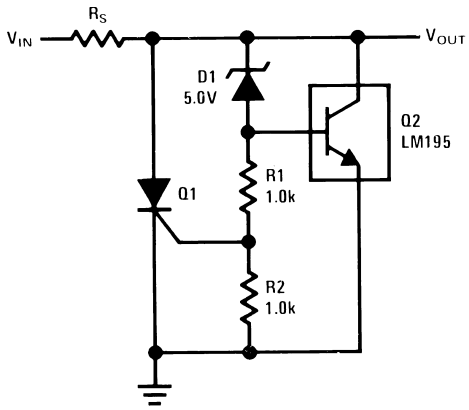


Figure 29. 6.0V Shunt Regulator with Crowbar

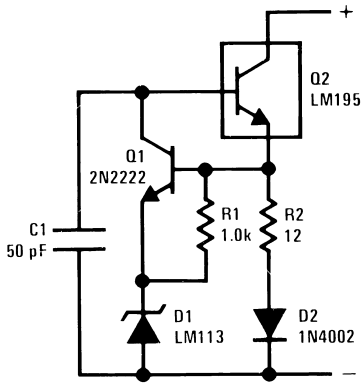
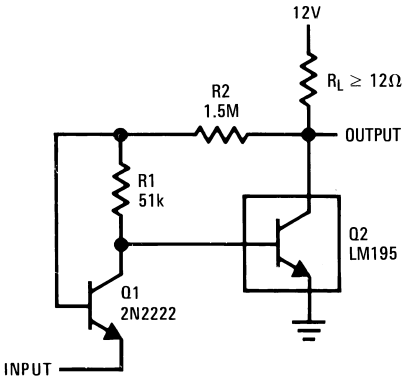
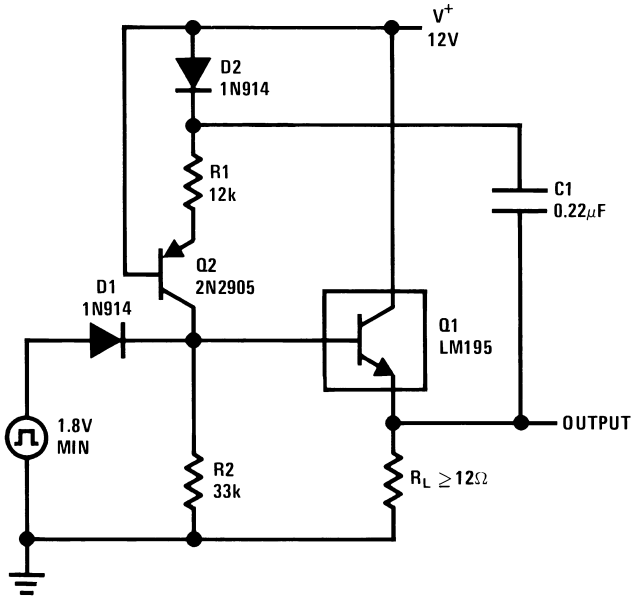


Figure 30. Two Terminal 100 mA Current Regulator



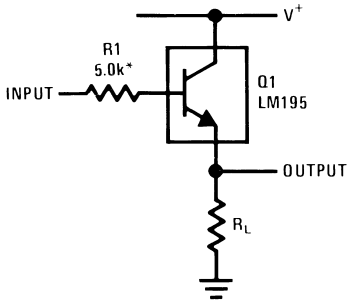
Turn ON = 350 mV
Turn OFF = 200 mV

Figure 31. Low Level Power Switch



T = R1C
R2 = 3R1
R2 ≤ 82k

Figure 32. Power One-Shot



*Need for Stability

Figure 33. Emitter Follower

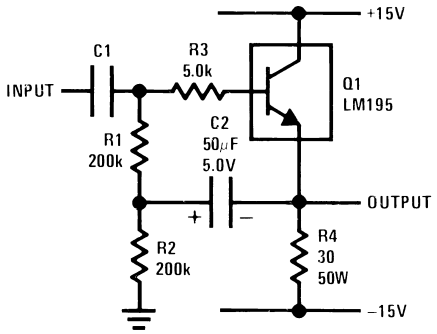
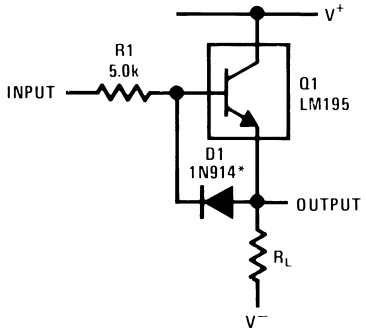
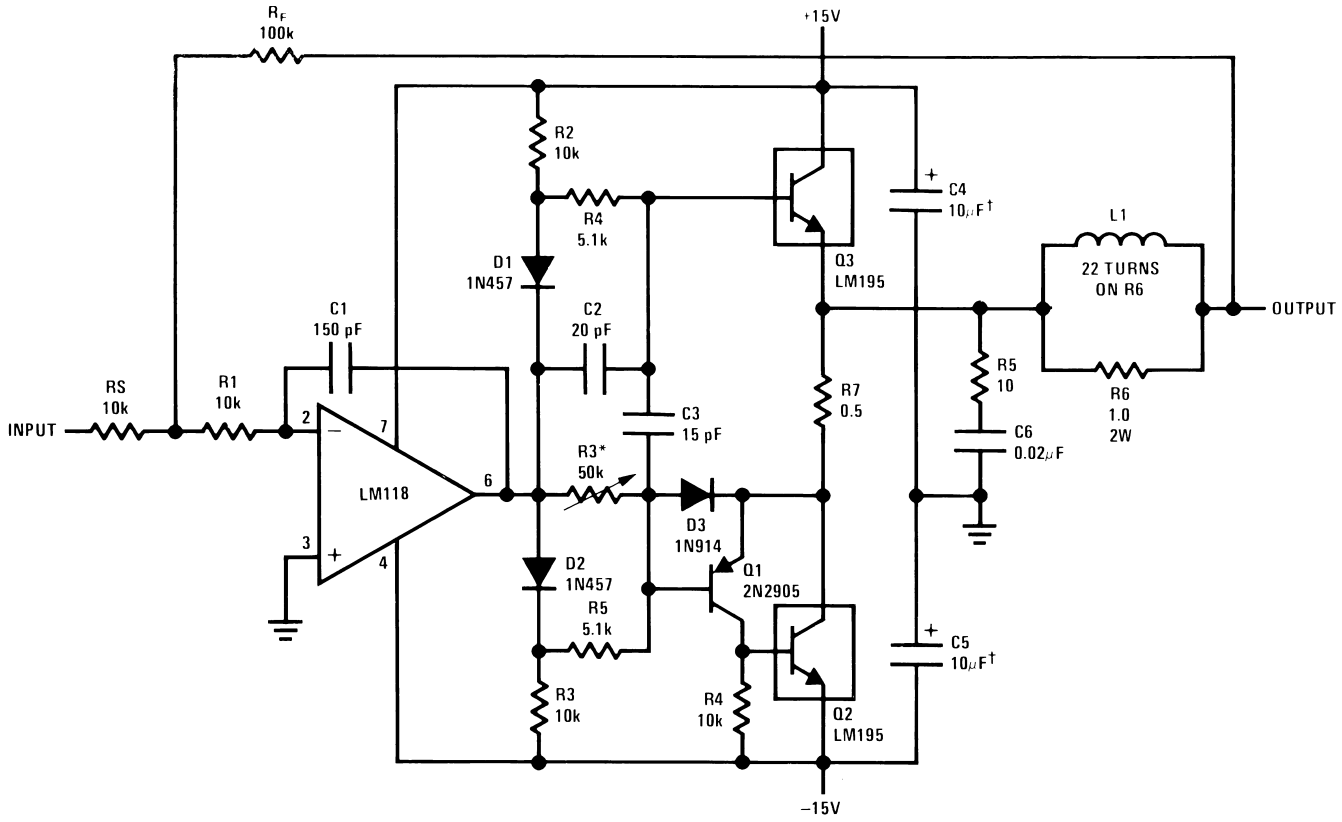


Figure 34. High Input Impedance AC Emitter Follower



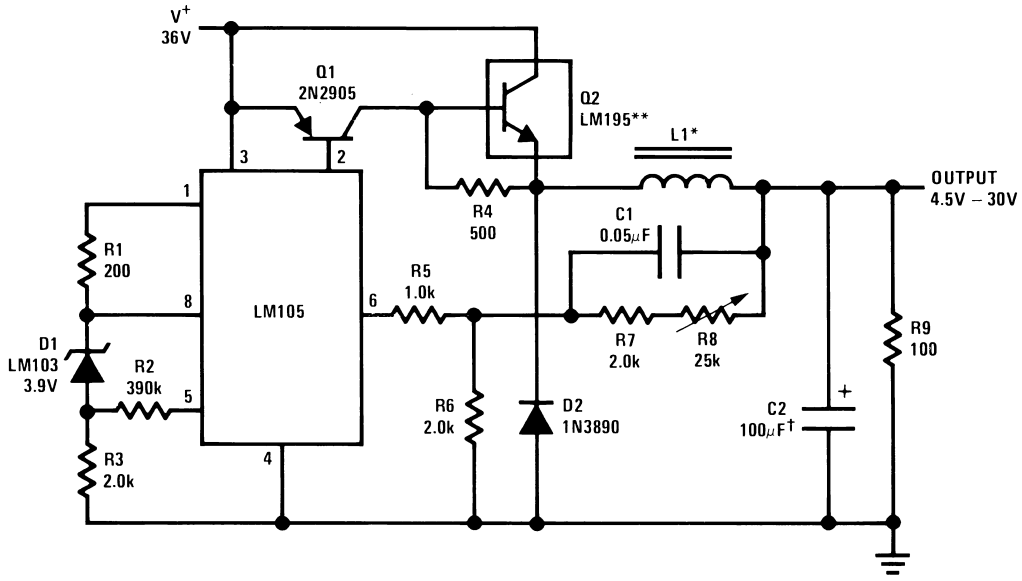
*Prevents storage with fast fall time square wave drive

Figure 35. Fast Follower



*Adjust for 50 mA quiescent current
†Solid Tantalum

Figure 36. Power Op Amp



*Sixty turns wound on Arnold Type A-083081-2 core.
**Four devices in parallel
†Solid tantalum

Figure 37. 6.0 Amp Variable Output Switching Regulator

REVISION HISTORY

Changes from Revision B (April 2013) to Revision C	Page
• Changed layout of National Data Sheet to TI format	15

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM395T	NRND	TO-220	NDE	3	45	TBD	Call TI	Call TI	0 to 125	LM395T	
LM395T/NOPB	ACTIVE	TO-220	NDE	3	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	0 to 125	LM395T	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

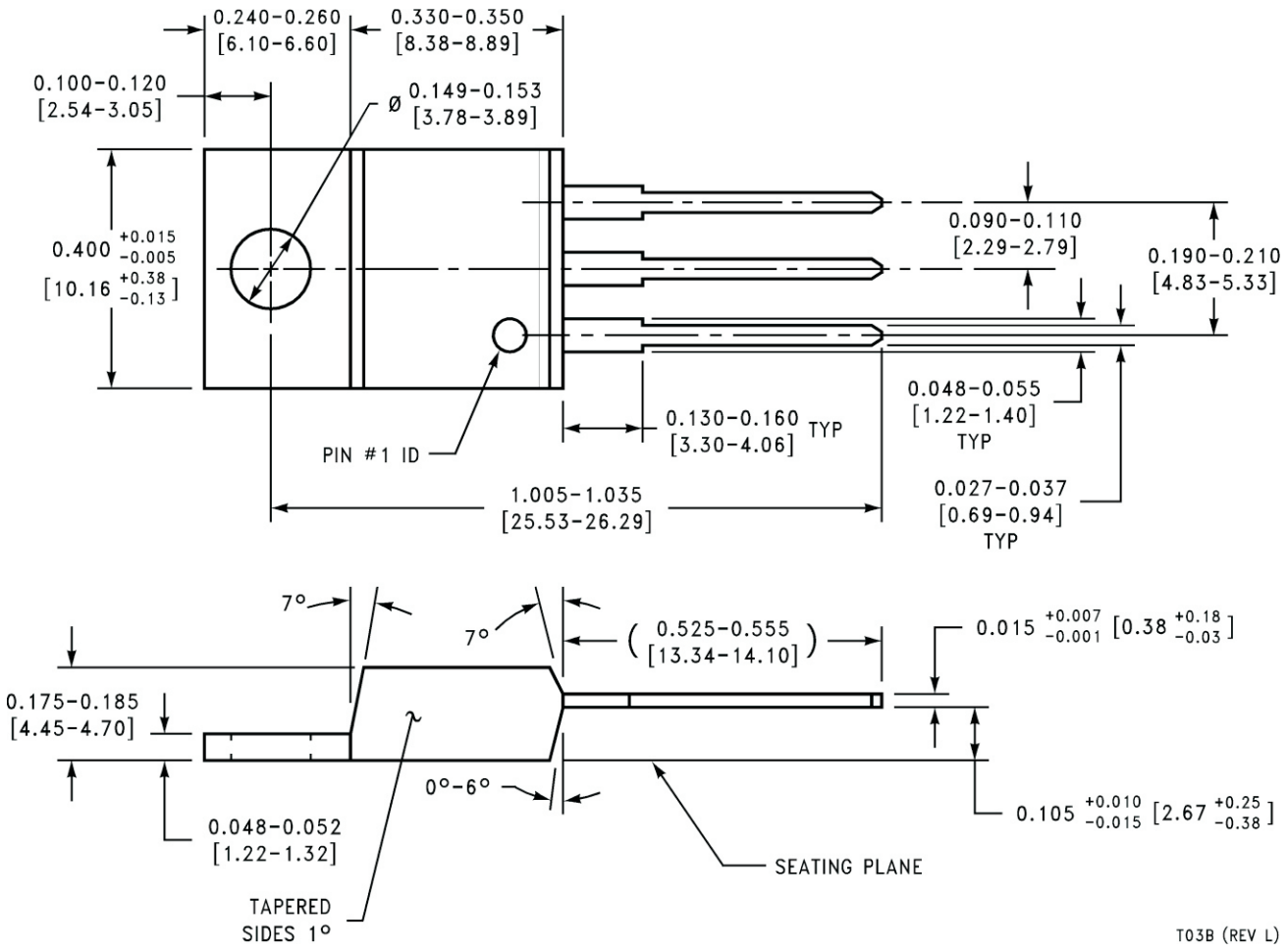
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

NDE0003B


0.240-0.260
[6.10-6.60]
0.330-0.350
[8.38-8.89]
0.100-0.120
[2.54-3.05]
Ø 0.149-0.153
[3.78-3.89]
0.400 +0.015 -0.005
[10.16 +0.38 -0.13]
0.090-0.110
[2.29-2.79]
0.190-0.210
[4.83-5.33]
0.048-0.055
[1.22-1.40]
TYP
0.130-0.160 TYP
[3.30-4.06]
PIN #1 ID
1.005-1.035
[25.53-26.29]
0.027-0.037
[0.69-0.94]
TYP
7°
7°
(0.525-0.555
[13.34-14.10])
0.015 +0.007 -0.001 [0.38 +0.18 -0.03]
0.175-0.185
[4.45-4.70]
0°-6°
0.105 +0.010 -0.015 [2.67 +0.25 -0.38]
0.048-0.052
[1.22-1.32]
SEATING PLANE
TAPERED
SIDES 1°
T03B (REV L)

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as “components”) are sold subject to TI’s terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI’s terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers’ products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers’ products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI’s goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or “enhanced plastic” are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have ***not*** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products		**Applications**	
Audio	www.ti.com/audio	Automotive and Transportation	www.ti.com/automotive
Amplifiers	amplifier.ti.com	Communications and Telecom	www.ti.com/communications
Data Converters	dataconverter.ti.com	Computers and Peripherals	www.ti.com/computers
DLP® Products	www.dlp.com	Consumer Electronics	www.ti.com/consumer-apps
DSP	dsp.ti.com	Energy and Lighting	www.ti.com/energy
Clocks and Timers	www.ti.com/clocks	Industrial	www.ti.com/industrial
Interface	interface.ti.com	Medical	www.ti.com/medical
Logic	logic.ti.com	Security	www.ti.com/security
Power Mgmt	power.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com		
OMAP Applications Processors	www.ti.com/omap	**TI E2E Community**	e2e.ti.com
Wireless Connectivity	www.ti.com/wirelessconnectivity		

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265